

VI TELEFILTER**SAW filter specification****TFS 460 B 1/4****Measurement condition**

Ambient temperature: 23 °C
 Input power level: 0 dBm
 Source impedance: 263 Ω || -0,45 pF
 Load impedance: 263 Ω || -0,45 pF

Construction, pin connection and 50 Ω test circuit

see page 2

Stability characteristics and packing

see page 3

Air reflow temperature conditions

see page 4

Characteristics

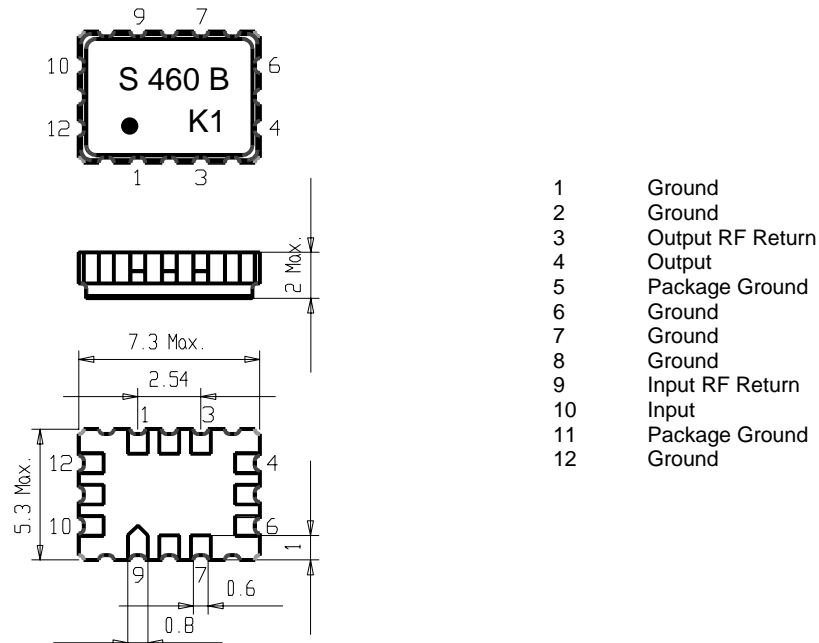
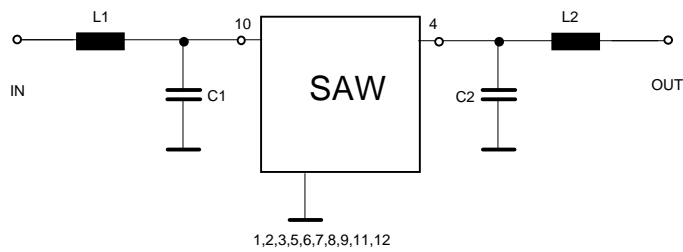
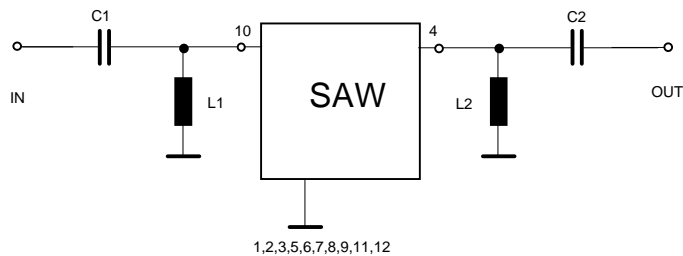
Remark:

Reference level for the relative attenuation a_{rel} of the TFS 460 is the minimum of the pass band attenuation a_{min} . The minimum of the pass band attenuation a_{min} is defined as the insertion loss a_e . The centre frequency f_o is the arithmetic mean value of the upper and lower frequencies at the 2 dB filter attenuation level relative to the insertion loss a_e . The nominal frequency f_N is fixed on 460 MHz without tolerance.

D a t a		typ. value		tolerance / limit	
Insertion loss (Reference level)	$a_e = a_{min}$	3	dB	max. 5	dB
Nominal frequency	f_N	-		460	MHz
Centre frequency	f_o	460	MHz	-	
Pass band ripple					
$f_N \pm 10$ MHz		1	dB	max. 2	dB
Relative attenuation a_{rel}					
360 MHz ... 380 MHz		> 60	dB	min. 50	dB
405 MHz ... 425 MHz		> 40	dB	min. 40	dB
Intermodulation					
IP_3	modulation signals: $f_N + 1$ MHz and $f_N + 2$ MHz, each of 10 dBm	40	dB	min. 20	dB
Permissible DC voltage V_{DC}					
				max. 12	V
Input power level					
				max. 10	dBm
Operating temperature range					
- 25 °C ... + 75 °C					
Storage temperature range					
- 40 °C ... + 85 °C					
Temperature coefficient of frequency TC_f					
		- 72	ppm/K	-	

Generated: _____

Checked / approved: _____

VI TELEFILTER**SAW filter specification****TFS 460 B 2/4****Construction and pin connection****50 Ω test circuit 1 *)****50 Ω test circuit 2 *)**

*) Both circuits are possible, but the behavior of the first circuit differs slightly from the second one. The final test at Telefilter is carried out with the first circuit.

VI TELEFILTER**SAW filter specification****TFS 460 B 3/4****Stability characteristics**

After the following tests the filter shall meet the whole specification:

1. Shock: 100g, 18 ms, half sine wave, 3 shocks each plane;
DIN IEC 68 T2 - 27
2. Vibration: 10 Hz to 500 Hz, 0.35 mm amplitude, 5g; 2 hours for 3 planes;
DIN IEC 68 T2 - 6
3. Damp heat: 90 % to 95 % rel. humidity, 40 °C, 10 days;
IEC Pub. 68 - 2 - 3
4. Resistance to solder heat (Reflow): 260 °C for 10 sec;

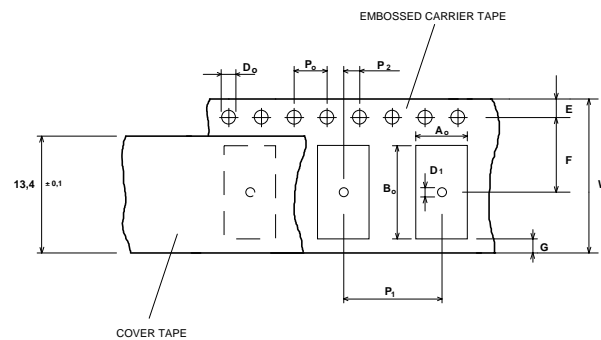
Packing

Tape & Reel: IEC 286 - 3, with exception of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;

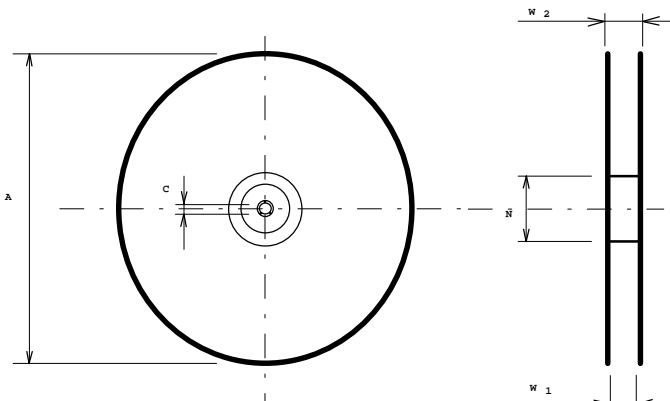
max. pieces of filters per reel: 3400

Tape (all dimensions in mm)

W	: 16 ± 0,3
Po	: 4 ± 0,1
Do	: 1,5 + 0,5
D1	: 1,5 + 0,5
E	: 1,75 ± 0,1
F	: 7,5 ± 0,1
G (min)	: 0,75
P2	: 2 ± 0,05
P1	: 8 ± 0,1
D1(min)	: 1,5
Ao	: 5,4 ± 0,1
Bo	: 7,4 ± 0,1

**Reel (all dimensions in mm):**

A	:	330
W1	:	16,4 +2
W2 (max)	:	22,4
N (min)	:	>= 90
C	:	13 ± 0,25



The minimum bending radius is 45 mm. The mounting surface of the filters faces the bottom side of the embossed carrier tape. The marking of the filters is able to read if the view is directed on the upper side of the carrier tape with the sprocket holes on the right side of the tape.

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Air reflow temperature conditions

1st and 2nd air reflow profile

Name:	pre-heating periods	main-heating periods	peak temperature
Temperature:	150 °C - 170 °C	over 200 °C	255 °C ± 5 °C
Time:	60 sec. - 90 sec.	20 sec. - 25 sec.	

Chip-mount air reflow profile

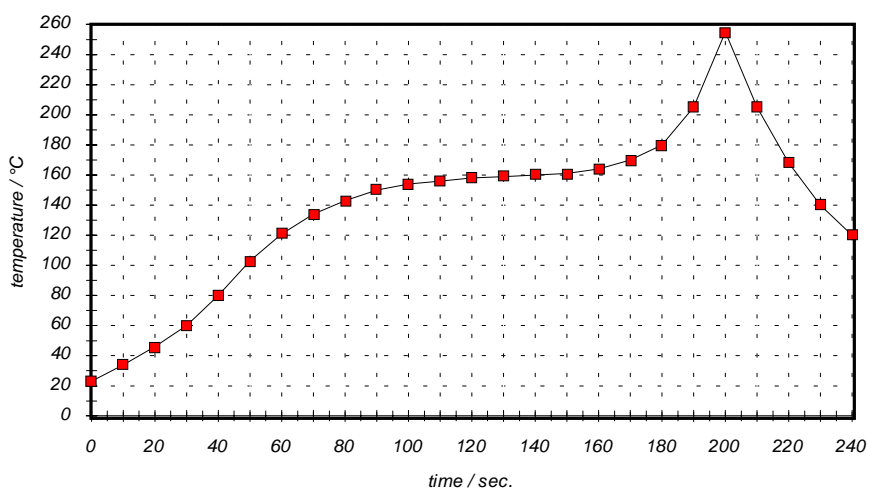


Table for temperature vs. time during the air reflow process

Tolerance of temperatures: ± 5 °C

time / sec.	temperature / °C	time / sec.	temperature / °C
0	23	140	160
10	34	150	161
20	46	160	164
30	60	170	170
40	80	180	180
50	103	190	205
60	121	195	230
70	134	200	255
80	143	205	230
90	150	210	205
100	154	215	180
110	156	220	165
120	158	230	140
130	159	240	120